February 2008



74LCX14 Low Voltage Hex Inverter with 5V Tolerant Schmitt Trigger Inputs

Features

- 5V tolerant inputs
- 2.3V–3.6V V_{CC} specifications provided
- 6.5ns t_{PD} max. (V_{CC} = 3.3V), 10µA I_{CC} max.
- Power down high impedance inputs and outputs
- ±24mA output drive (V_{CC} = 3.0V)
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds JEDEC 78 conditions
- ESD performance:
- Human body model > 2000V
- Machine model > 200V
- Leadless DQFN package

General Description

The LCX14 contains six inverter gates each with a Schmitt trigger input. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have a greater noise margin than conventional inverters.

The LCX14 has hysteresis between the positive-going and negative-going input thresholds (typically 1.0V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

The inputs tolerate voltages up to 7V allowing the interface of 5V, 3V and 2.5V systems.

The 74LCX14 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Ordering Information

| Order Number | Package Number | Package Description |
|---------------------------|-------------------|---|
| 74LCX14M | M14A | 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow |
| 74LCX14SJ | M14D | 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74LCX14BQX ⁽¹⁾ | MLP14A | 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm |
| 74LCX14MTC | MTC14 | 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |

Note:

1. DQFN package available in Tape and Reel only.

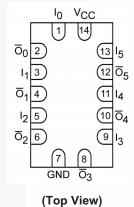
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

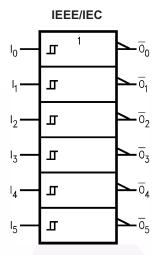
Connection Diagrams Pin Assignments for SOIC, SOP, and TSSOP 14 V_{CC} I₀ 13 $\overline{0}_0$ I₅ 12 05 h 11 $\overline{0}_1$ ا₄ 10 I_2

 $\begin{array}{c} 1_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{3} \\ \hline 0_{1} \\ \hline 0_{1} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \hline 0_{3} \hline \hline 0_{3} \hline 0_{3} \hline \hline 0_{3} \hline$

Pad Assignments for DQFN



Logic Symbol



Truth Table

| Input | Output |
|-------|--------|
| A | ō |
| L | Н |
| Н | L |

Pin Description

| Pin Names | Description |
|----------------|-------------|
| I _n | Inputs |
| Ōn | Outputs |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Rating |
|------------------|---|---------------------------------|
| V _{CC} | Supply Voltage | -0.5V to +7.0V |
| VI | DC Input Voltage | -0.5V to +7.0V |
| Vo | DC Output Voltage, Output in HIGH or LOW State ⁽²⁾ | -0.5V to V _{CC} + 0.5V |
| I _{IK} | DC Input Diode Current, V _I < GND | –50mA |
| I _{ОК} | DC Output Diode Current | |
| | V _O < GND | –50mA |
| | V _O > V _{CC} | +50mA |
| Ι _Ο | DC Output Source/Sink Current | ±50mA |
| I _{CC} | DC Supply Current per Supply Pin | ±100mA |
| I _{GND} | DC Ground Current per Ground Pin | ±100mA |
| T _{STG} | Storage Temperature | –65°C to +150°C |

Note:

2. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions⁽³⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Min. | Max. | Units |
|-----------------------------------|-----------------------------------|------|-----------------|-------|
| V _{CC} | Supply Voltage | | | |
| | Operating | 2.0 | 3.6 | V |
| | Data Retention | 1.5 | 3.6 | |
| VI | Input Voltage | 0 | 5.5 | V |
| Vo | Output Voltage, HIGH or LOW State | 0 | V _{CC} | V |
| I _{OH} / I _{OL} | Output Current | | | |
| | $V_{CC} = 3.0V - 3.6V$ | | ±24 | mA |
| | V _{CC} = 2.7V–3.0V | | ±12 | |
| | $V_{CC} = 2.3V - 2.7V$ | | ±8 | |

Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| | | | | T _A =40°C | to +85°C | |
|------------------|---------------------------------------|---------------------|------------------------------------|-----------------------|----------|-------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min. | Max. | Units |
| V _{t+} | Positive Input Threshold | 2.5 | | 0.9 | 1.7 | V |
| | | 3.0 | | 1.2 | 2.2 | |
| V _t - | Negative Input Threshold | 2.5 | | 0.4 | 1.1 | V |
| | | 3.0 | | 0.6 | 1.5 | |
| V _H | Hysteresis | 2.5 | | 0.3 | 1.0 | V |
| | | 3.0 | | 0.4 | 1.2 | |
| V _{OH} | HIGH Level Output Voltage | 2.3–3.6 | $I_{OH} = -100 \mu A$ | V _{CC} - 0.2 | | V |
| | | 2.3 | I _{OH} = -8mA | 1.8 | | |
| | | 2.7 | $I_{OH} = -12mA$ | 2.2 | | |
| | | 3.0 | $I_{OH} = -18mA$ | 2.4 | | |
| | | 3.0 | $I_{OH} = -24mA$ | 2.2 | | |
| V _{OL} | LOW Level Output Voltage | 2.3–3.6 | $I_{OL} = 100 \mu A$ | | 0.2 | V |
| | | 2.3 | I _{OL} = 8mA | | 0.6 | |
| | | 2.7 | $I_{OL} = 12mA$ | | 0.4 | |
| | | 3.0 | I _{OL} = 16mA | | 0.4 | |
| | | 3.0 | $I_{OL} = 24 \text{mA}$ | | 0.55 | |
| l _l | Input Leakage Current | 2.3–3.6 | $0 \le V_I \le 5.5V$ | | ±5.0 | μA |
| I _{OFF} | Power-Off Leakage Current | 0 | $V_{\rm I}$ or $V_{\rm O} = 5.5 V$ | | 10 | μA |
| I _{CC} | Quiescent Supply Current | 2.3–3.6 | $V_{I} = V_{CC}$ or GND | | 10 | μA |
| | | | $3.6V \le V_I \le 5.5V$ | | ±10 | |
| ΔI_{CC} | Increase in I _{CC} per Input | 2.3–3.6 | $V_{IH} = V_{CC} - 0.6V$ | | 500 | μA |

AC Electrical Characteristics

| | | | $T_A = -40^{\circ}C$ to +85°C, $R_L = 500\Omega$ | | | | | |
|---------------------------------------|--------------------------------------|------|--|------|-----------------|---|--------------------|-------|
| | | | 3V ± 0.3V, 50pF | | ₌ 2.7V, 50pF | V _{CC} = 2.5 C _L = | 5V ± 0.2V, 30pF | |
| Symbol | Parameter | Min. | Max. | Min. | Max. | Min. | Max. | Units |
| t _{PHL} , t _{PLH} | Propagation Delay | 1.5 | 6.5 | 1.5 | 7.5 | 1.5 | 7.8 | ns |
| t _{OSHL} , t _{OSLH} | Output to Output Skew ⁽⁴⁾ | | 1.0 | | | | | ns |

Note:

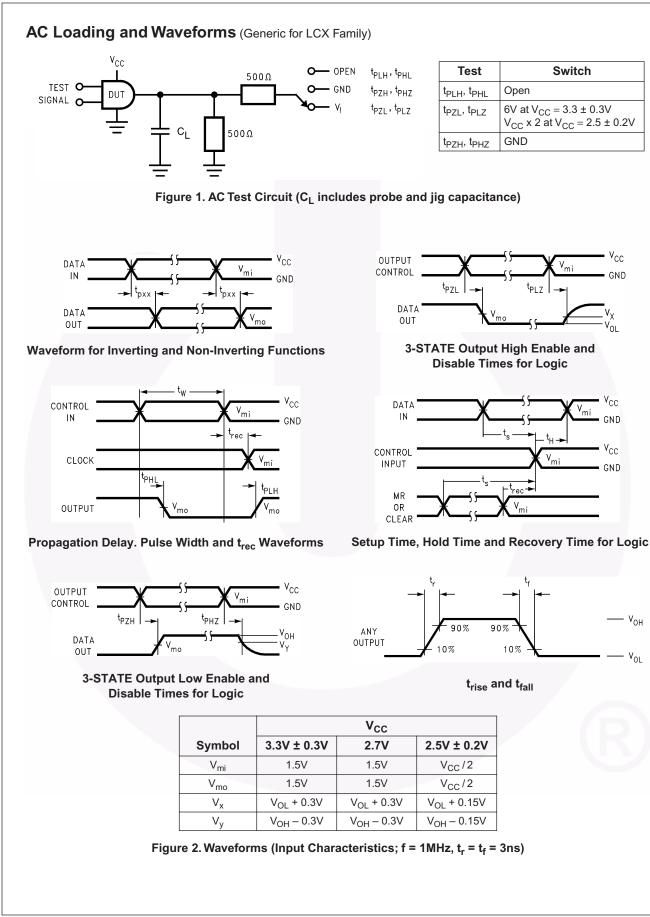
4. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

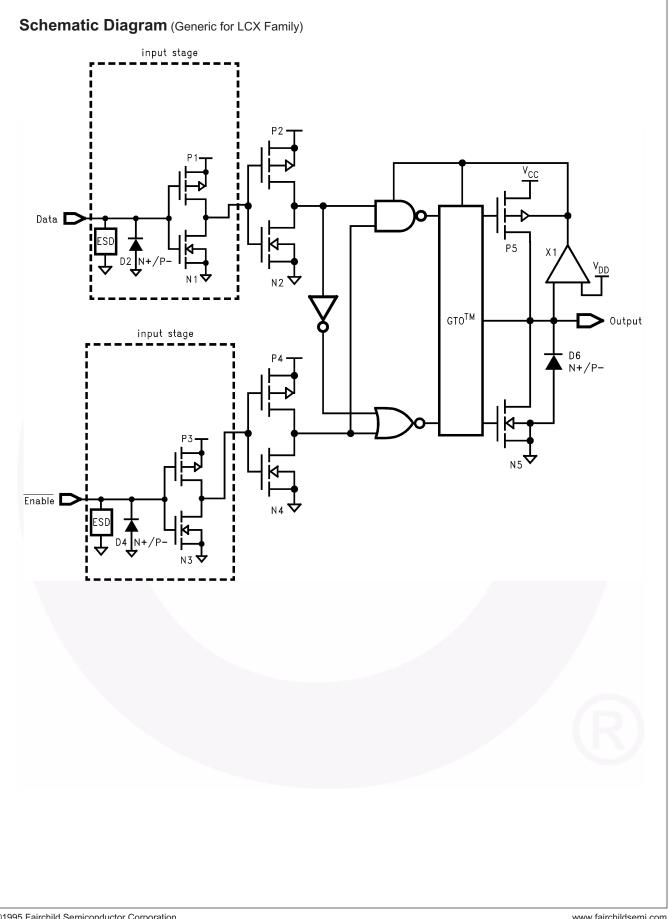
Dynamic Switching Characteristics

| | | | | $T_A = 25^{\circ}C$ | |
|------------------|---|---------------------|---|---------------------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Typical | Unit |
| V _{OLP} | Quiet Output Dynamic Peak V _{OL} | 3.3 | $C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$ | 0.8 | V |
| | | 2.5 | $C_L = 30 pF$, $V_{IH} = 2.5V$, $V_{IL} = 0V$ | 0.6 | |
| V _{OLV} | Quiet Output Dynamic Valley V_{OL} | 3.3 | $C_L = 50 pF$, $V_{IH} = 3.3V$, $V_{IL} = 0V$ | -0.8 | V |
| | | 2.5 | $C_{L} = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$ | -0.6 | |

Capacitance

| Symbol | Parameter | Conditions | Typical | Units |
|------------------|-------------------------------|--|---------|-------|
| C _{IN} | Input Capacitance | $V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$ | 7 | pF |
| C _{OUT} | Output Capacitance | $V_{CC} = 3.3 V$, $V_I = 0 V$ or V_{CC} | 8 | pF |
| C _{PD} | Power Dissipation Capacitance | $V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC} , f = 10MHz | 25 | pF |





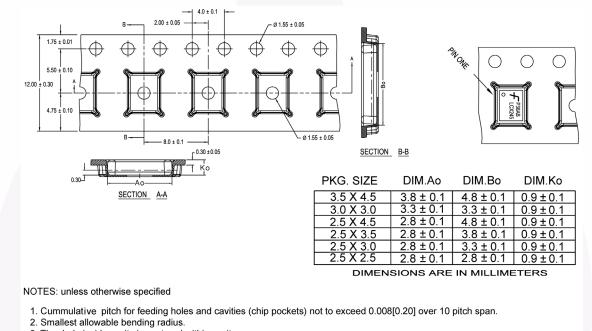
7

Tape and Reel Specification

Tape Format for DQFN

| Package Designator | Tape Section | Number of Cavities | Cavity Status | Cover Tape Status |
|--------------------|--------------------|--------------------|---------------|-------------------|
| BQX | Leader (Start End) | 125 (Тур.) | Empty | Sealed |
| | Carrier | 3000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Тур.) | Empty | Sealed |

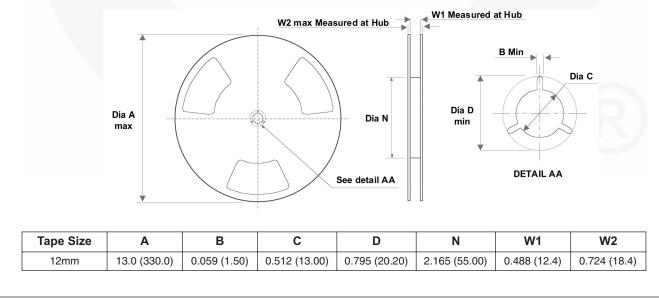
Tape Dimensions inches (millimeters)

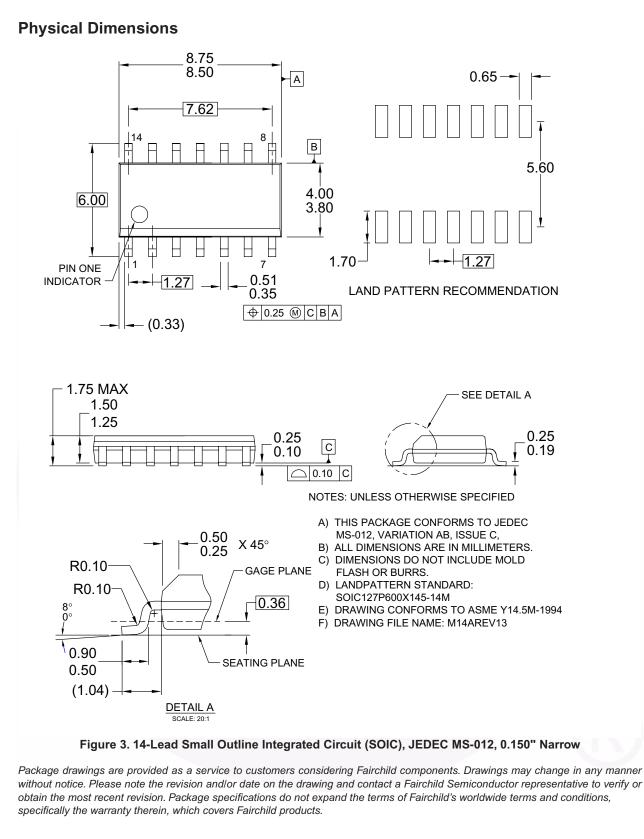


3. Thru hole inside cavity is centered within cavity.

- 4. Tolerance is $\pm 0.002[0.05]$ for these dimensions on all 12mm tapes.
- 5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
- 6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
- 8. Controlling dimension is millimeter. Diemension in inches rounded.

Reel Dimensions inches (millimeters)

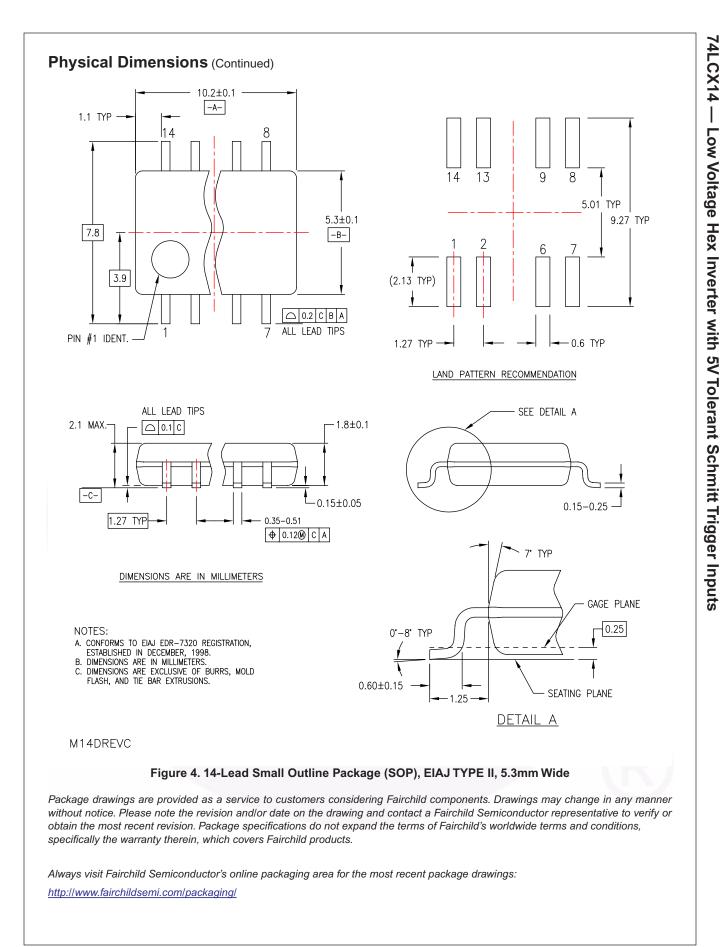




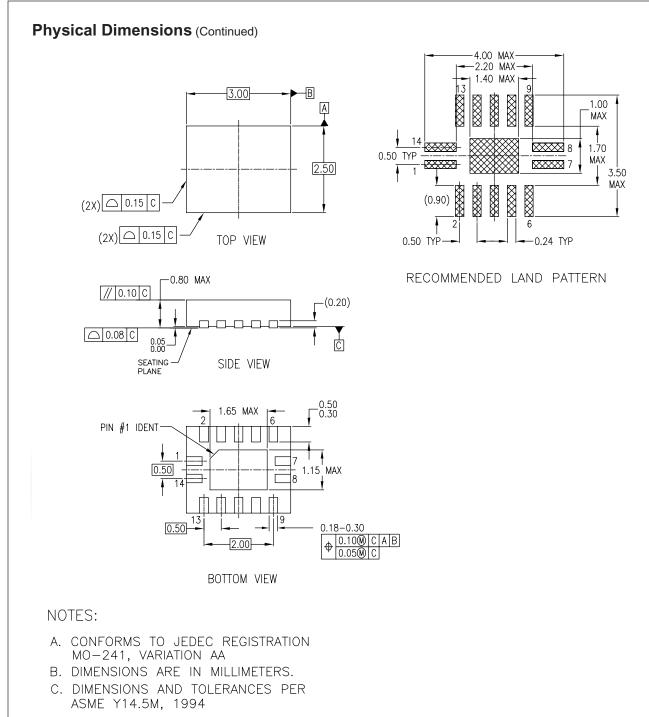
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

74LCX14 — Low Voltage Hex Inverter with 5V Tolerant Schmitt Trigger Inputs



10



MLP14ArevA

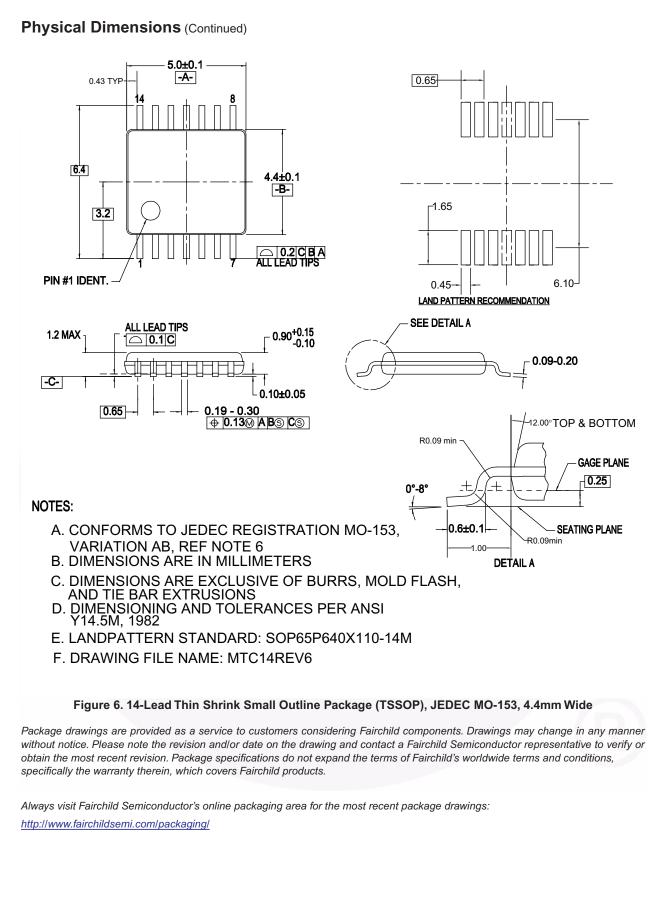
Figure 5. 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

74LCX14 — Low Voltage Hex Inverter with 5V Tolerant Schmitt Trigger Inputs





SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

* EZSWITCHTM and FlashWriter[®] are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
 - 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|--|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only. |

PRODUCT STATUS DEFINITIONS